

F97 Series



Resin-Molded Chip, Improved Reliability J-Lead



FEATURES

- Compliant to the RoHS2 directive 2011/65/EU
- Compliant to AEC-Q200
- Improved reliability - FR=0.5%/1000hrs (twice better than standard)
- SMD J-lead



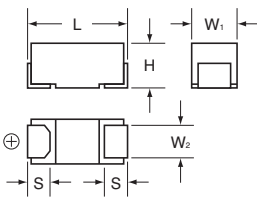
APPLICATIONS

- Automotive electronics (Engine ECU)
- Industrial equipment

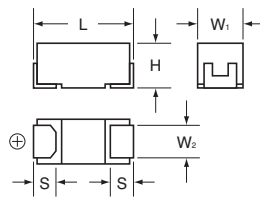
CASE DIMENSIONS: millimeters (inches)

Code	EIA Code	EIA Metric	L	W ₁	W ₂	H	S
A	1206	3216-18	3.20 ± 0.20 (0.126 ± 0.008)	1.60 ± 0.20 (0.063 ± 0.008)	1.20 ± 0.10 (0.047 ± 0.004)	1.60 ± 0.20 (0.063 ± 0.008)	0.80 ± 0.20 (0.031 ± 0.008)
B	1210	3528-21	3.50 ± 0.20 (0.126 ± 0.008)	2.80 ± 0.20 (0.110 ± 0.008)	2.20 ± 0.10 (0.087 ± 0.004)	1.90 ± 0.20 (0.075 ± 0.008)	0.80 ± 0.20 (0.031 ± 0.008)
C	2312	6032-27	6.00 ± 0.20 (0.236 ± 0.008)	3.20 ± 0.20 (0.126 ± 0.008)	2.20 ± 0.10 (0.087 ± 0.004)	2.50 ± 0.20 (0.098 ± 0.008)	1.30 ± 0.20 (0.051 ± 0.008)
N	2917	7343-30	7.30 ± 0.20 (0.287 ± 0.008)	4.30 ± 0.20 (0.169 ± 0.008)	2.40 ± 0.10 (0.094 ± 0.004)	2.80 ± 0.20 (0.110 ± 0.008)	1.30 ± 0.20 (0.051 ± 0.008)

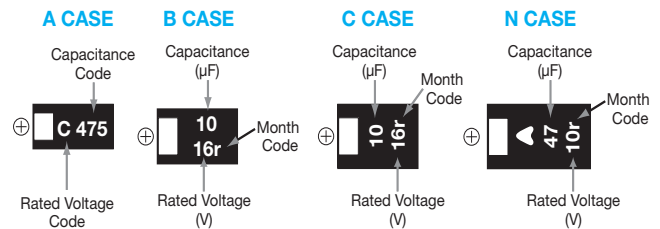
A, B CASE



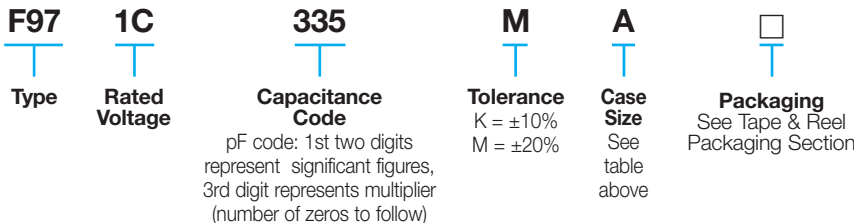
C, N CASE



MARKING



HOW TO ORDER



TECHNICAL SPECIFICATIONS

Category Temperature Range:	-55 to +125°C
Rated Temperature:	+85°C
Capacitance Tolerance:	±20%, ±10% at 120Hz
Dissipation Factor:	Refer to next page
ESR 100kHz:	Refer to next page
Leakage Current:	After 1 minute's application of rated voltage, leakage current at 20°C is not more than 0.01CV or 0.5µA, whichever is greater. After 1 minute's application of rated voltage, leakage current at 85°C is not more than 0.1CV or 5µA, whichever is greater. After 1 minute's application of derated voltage, leakage current at 125°C is not more than 0.125CV or 6.3µA, whichever is greater.
Capacitance Change By Temperature	+15% Max. at +125°C +10% Max. at +85°C -10% Max. at -55°C

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CAPACITANCE AND RATED VOLTAGE RANGE (LETTER DENOTES CASE SIZE)

Capacitance		Rated Voltage					
μF	Code	6.3V (0J)	10V (1A)	16V (1C)	20V (1D)	25V (1E)	35V (1V)
0.33	334						A
0.47	474						A
0.68	684				A	A	A
1.0	105			A	A	A	A*/B
1.5	155			A	A		A*/B
2.2	225		A	A	A	A*/B	B
3.3	335	A	A	A	B	B	B*/C
4.7	475	A	A/B	A/B	A/B	B*/C	C
6.8	685	A/B	B	B	B*/C	C	C*/N
10	106		A/B	A/B/C	B*/C	C/N	N
15	156	B	B	A/B*/C	N	C*/N	
22	226	A/B	A/B	B/C/N	C/N	N	
33	336	A/C	B/C/N	B/C/N		N*	
47	476	B/C	B/C/N	C/N			
68	686	N	N				
100	107	N	C/N*				
150	157	C					

Available Ratings

*Codes under development – subject to change

Please contact to your local AVX sales office when these series are being designed in your application.

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RATINGS & PART NUMBER REFERENCE

AVX Part No.	Case Size	Capacitance (μF)	Rated Voltage (V)	DCL (μA)	DF @ 120Hz (%)	ESR @ 100kHz (Ω)	*1 ΔC/C (%)
6.3 Volt							
F970J335MAA	A	3.3	6.3	0.5	4	4.5	*
F970J475MAA	A	4.7	6.3	0.5	6	4.0	*
F970J685MAA	A	6.8	6.3	0.5	6	3.5	*
F970J685MBA	B	6.8	6.3	0.5	6	2.5	*
F970J156MBA	B	15	6.3	0.9	6	2.0	*
F970J226MAA	A	22	6.3	1.4	12	2.5	*
F970J226MBA	B	22	6.3	1.4	8	1.9	*
F970J336MAA	A	33	6.3	2.1	12	2.5	*
F970J336MCC	C	33	6.3	2.1	6	1.1	*
F970J476MBA	B	47	6.3	3.0	8	1.0	*
F970J476MCC	C	47	6.3	3.0	6	0.9	*
F970J686MNC	N	68	6.3	4.3	6	0.6	*
F970J107MNC	N	100	6.3	6.3	8	0.6	*
F970J157MCC	C	150	6.3	9.5	12	0.7	*
10 Volt							
F971A225MAA	A	2.2	10	0.5	4	5.0	*
F971A335MAA	A	3.3	10	0.5	4	4.5	*
F971A475MAA	A	4.7	10	0.5	6	4.0	*
F971A475MBA	B	4.7	10	0.5	6	2.8	*
F971A685MBA	B	6.8	10	0.7	6	2.5	*
F971A106MAA	A	10	10	1.0	6	3.0	*
F971A106MBA	B	10	10	1.0	6	2.0	*
F971A156MBA	B	15	10	1.5	6	2.0	*
F971A226MAA	A	22	10	2.2	15	3.0	*
F971A226MBA	B	22	10	2.2	8	1.9	*
F971A336MBA	B	33	10	3.3	8	1.9	*
F971A336MCC	C	33	10	3.3	6	1.1	*
F971A336MNC	N	33	10	3.3	6	0.7	*
F971A476MBA	B	47	10	4.7	10	1.0	*
F971A476MCC	C	47	10	4.7	8	0.9	*
F971A476MNC	N	47	10	4.7	6	0.7	*
F971A686MNC	N	68	10	6.8	6	0.6	*
F971A107MCC	C	100	10	10.0	10	0.7	*
16 Volt							
F971C105MAA	A	1	16	0.5	4	7.5	*
F971C155MAA	A	1.5	16	0.5	4	6.3	*
F971C225MAA	A	2.2	16	0.5	4	5.0	*
F971C335MAA	A	3.3	16	0.5	4	4.5	*
F971C475MAA	A	4.7	16	0.8	8	4.0	*
F971C475MBA	B	4.7	16	0.8	6	2.8	*
F971C685MBA	B	6.8	16	1.1	6	2.5	*
F971C106MAA	A	10	16	1.6	8	3.5	*
F971C106MBA	B	10	16	1.6	6	2.1	*
F971C106MCC	C	10	16	1.6	6	1.5	*

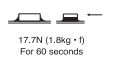
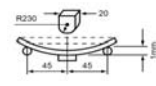
AVX Part No.	Case Size	Capacitance (μF)	Rated Voltage (V)	DCL (μA)	DF @ 120Hz (%)	ESR @ 100kHz (Ω)	*1 ΔC/C (%)
F971C156MAA	A	15	16	2.4	12	3.5	±10
F971C156MCC	C	15	16	2.4	6	1.2	*
F971C226MBA	B	22	16	3.5	8	1.9	*
F971C226MCC	C	22	16	3.5	8	1.1	*
F971C226MNC	N	22	16	3.5	6	0.7	*
F971C336MBA	B	33	16	5.3	10	2.1	*
F971C336MCC	C	33	16	5.3	8	1.1	*
F971C336MNC	N	33	16	5.3	6	0.7	*
F971C476MCC	C	47	16	7.5	10	1.1	*
F971C476MNC	N	47	16	7.5	8	0.7	*
20 Volt							
F971D684MAA	A	0.68	20	0.5	4	7.6	*
F971D105MAA	A	1	20	0.5	4	7.5	*
F971D155MAA	A	1.5	20	0.5	4	6.7	*
F971D225MAA	A	2.2	20	0.5	6	6.3	*
F971D335MBA	B	3.3	20	0.7	4	3.1	*
F971D475MAA	A	4.7	20	0.9	8	4.0	*
F971D475MBA	B	4.7	20	0.9	6	2.8	*
F971D685MCC	C	6.8	20	1.4	6	1.8	*
F971D106MCC	C	10	20	2.0	6	1.5	*
F971D156MNC	N	15	20	3.0	6	0.7	*
F971D226MCC	C	22	20	4.4	8	1.1	*
F971D226MNC	N	22	20	4.4	6	0.7	*
25 Volt							
F971E684MAA	A	0.68	25	0.5	4	7.6	*
F971E105MAA	A	1	25	0.5	4	7.5	*
F971E225MBA	B	2.2	25	0.6	4	3.8	*
F971E335MBA	B	3.3	25	0.8	4	3.5	*
F971E475MCC	C	4.7	25	1.2	6	1.8	*
F971E685MCC	C	6.8	25	1.7	6	1.8	*
F971E106MCC	C	10	25	2.5	6	1.6	*
F971E106MNC	N	10	25	2.5	6	1.0	*
F971E156MNC	N	15	25	3.8	6	0.7	*
F971E226MNC	N	22	25	5.5	6	0.7	*
35 Volt							
F971V334MAA	A	0.33	35	0.5	4	12.0	*
F971V474MAA	A	0.47	35	0.5	4	10.0	*
F971V684MAA	A	0.68	35	0.5	4	7.6	*
F971V105MBA	B	1	35	0.5	4	4.0	*
F971V155MBA	B	1.5	35	0.5	4	4.0	*
F971V225MBA	B	2.2	35	0.8	4	3.8	*
F971V335MCC	C	3.3	35	1.2	4	2.0	*
F971V475MCC	C	4.7	35	1.6	6	1.8	*
F971V685MNC	N	6.8	35	2.4	6	1.0	*
F971V106MNC	N	10	35	3.5	6	1.0	*

* In case of capacitance tolerance ± 10% type, "K" will be put at 9th digit of type numbering system

1: ΔC/C Marked ""

Item	All Case (%)
Damp Heat	±10
Temperature cycles	±5
Resistance soldering heat	±5
Surge	±5
Endurance	±10
Load Humidity	±10

QUALIFICATION TABLE

TEST	F97 series (Temperature range -55°C to +125°C)	
	Condition	
Damp Heat (Steady State)	At 85°C, 85% R.H., 1000 hours (No voltage applied) Capacitance Change Refer to page 149 (*1) Dissipation Factor Initial specified value or less Leakage Current 125% or less than the initial specified value	
Load Humidity	After 1000 hour's application of rated voltage in series with a 33Ω resistor at 85°C, 85% R.H., capacitors meet the characteristics requirements table below. Capacitance Change Refer to page 149 (*1) Dissipation Factor 120% or less than the initial specified value Leakage Current 200% of less than the initial specified value	
Temperature Cycles	At -55°C / +125°C, 30 minutes each, 1000 cycles Capacitance Change Refer to page 149 (*1) Dissipation Factor Initial specified value or less Leakage Current Initial specified value or less	
Resistance to Soldering Heat	10 seconds reflow at 260°C, 5 seconds immersion at 260°C. Capacitance Change Refer to page 149 (*1) Dissipation Factor Initial specified value or less Leakage Current Initial specified value or less	
Solderability	After immersing capacitors completely into a solder pot at 245°C for 2 to 3 seconds, more than 3/4 of their electrode area shall remain covered with new solder.	
Surge	After application of surge voltage in series with a 33Ω resistor at the rate of 30 seconds ON, 30 seconds OFF, for 1000 successive test cycles at 85°C, capacitors shall meet the characteristic requirements in the table above. Capacitance Change Refer to page 149 (*1) Dissipation Factor Initial specified value or less Leakage Current Initial specified value or less	
Endurance	After 2000 hours' application of rated voltage in series with a 3Ω resistor at 85°C, or derated voltage in series with a 3Ω resistor at 125°C, capacitors shall meet the characteristic requirements in the table above. Capacitance Change Refer to page 149 (*1) Dissipation Factor Initial specified value or less Leakage Current Initial specified value or less	
Shear Test	After applying the pressure load of 17.7N for 60 seconds horizontally to the center of capacitor side body which has no electrode and has been soldered beforehand on a substrate, there shall be found neither exfoliation nor its sign at the terminal electrode..	
Terminal Strength	Keeping a capacitor surface-mounted on a substrate upside down and supporting the substrate at both of the opposite bottom points 45mm apart from the center of capacitor, the pressure strength is applied with a specified jig at the center of the substrate so that substrate may bend by 1mm as illustrated. Then, there shall be found no remarkable abnormality on the capacitor terminals.	
Failure Rate	0.5% per 1000 hours at 85°C, V _R with 0.1Ω/V series impedance, 60% confidence level.	